ne<mark>x</mark>peria

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Should be replaced with:

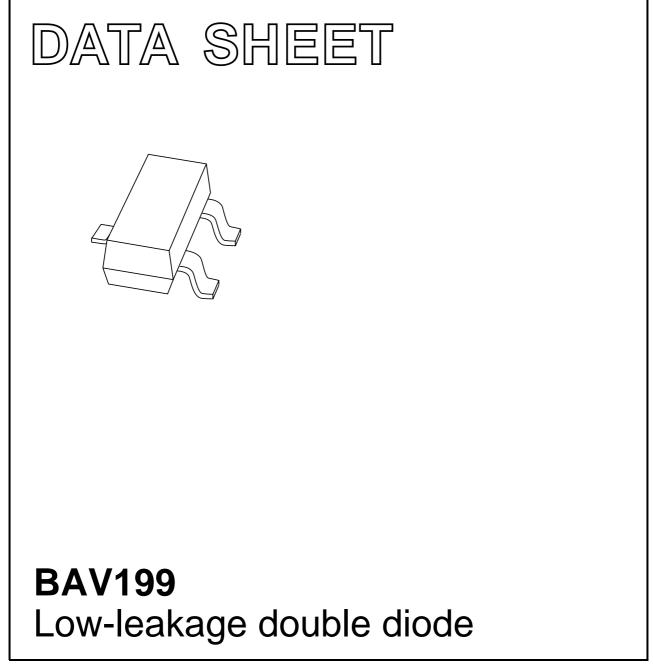
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 1999 May 11 2001 Oct 12



MARKING

Note

TYPE NUMBER

BAV199

1. * = p: Made in Hong Kong.

* = t: Made in Malaysia.

* = W: Made in China.

FEATURES

- Plastic SMD package
- Low leakage current: typ. 3 pA
- Switching time: typ. 0.8 μs
- Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 85 V
- Repetitive peak forward current: max. 500 mA.

APPLICATION

• Low-leakage current applications in surface mounted circuits.

DESCRIPTION

Epitaxial, medium-speed switching, double diode in a small SOT23 plastic SMD package. The diodes are connected in series.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per diode					
V _{RRM}	repetitive peak reverse voltage		-	85	V
V _R	continuous reverse voltage		-	75	V
I _F	continuous forward current	single diode loaded; note 1; see Fig.2	-	160	mA
		double diode loaded; note 1; see Fig.2	-	140	mA
I _{FRM}	repetitive peak forward current		-	500	mA
I _{FSM}	non-repetitive peak forward current	square wave; T _j = 25 °C prior to surge; see Fig.4			
		$t_p = 1 \ \mu s$	_	4	А
		t _p = 1 ms	_	1	А
		$t_p = 1 s$	_	0.5	А
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1	-	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

Note

1. Device mounted on a FR4 printed-circuit board.

Product data sheet

BAV199

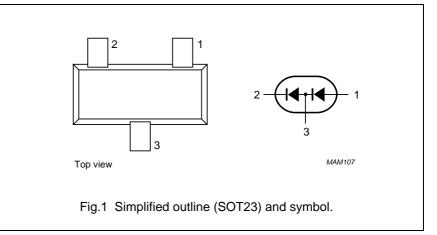
PINNING

MARKING

CODE⁽¹⁾

JY*

PIN	DESCRIPTION
1	anode
2	cathode
3	anode; cathode



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BAV199

ELECTRICAL CHARACTERISTICS

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
Per diode		·			
V _F	forward voltage	see Fig.3			
		I _F = 1 mA	-	900	mV
		I _F = 10 mA	_	1000	mV
		I _F = 50 mA	-	1100	mV
		I _F = 150 mA	-	1250	mV
I _R	reverse current	see Fig.5			
		V _R = 75 V	0.003	5	nA
		V _R = 75 V; T _j = 150 °C	3	80	nA
C _d	diode capacitance	$f = 1 MHz; V_R = 0; see Fig.6$	2	-	pF
t _{rr}	reverse recovery time	when switched from $I_F = 10$ mA to $I_R = 10$ mA; $R_L = 100 \Omega$; measured at $I_R = 1$ mA; see Fig.7	0.8	3	μs

THERMAL CHARACTERISTICS

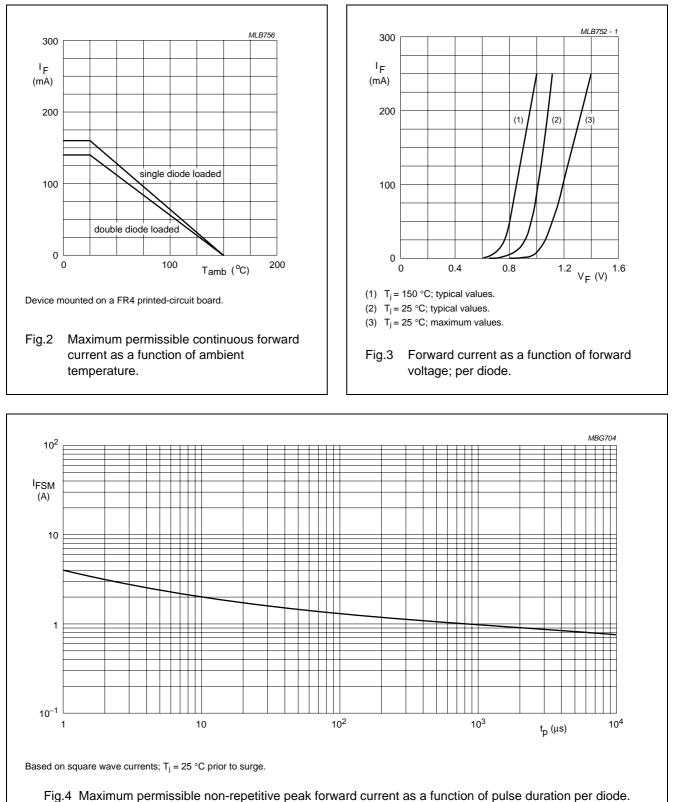
SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-tp}	thermal resistance from junction to tie-point		360	K/W
R _{th j-a}	thermal resistance from junction to ambient	note 1	500	K/W

Note

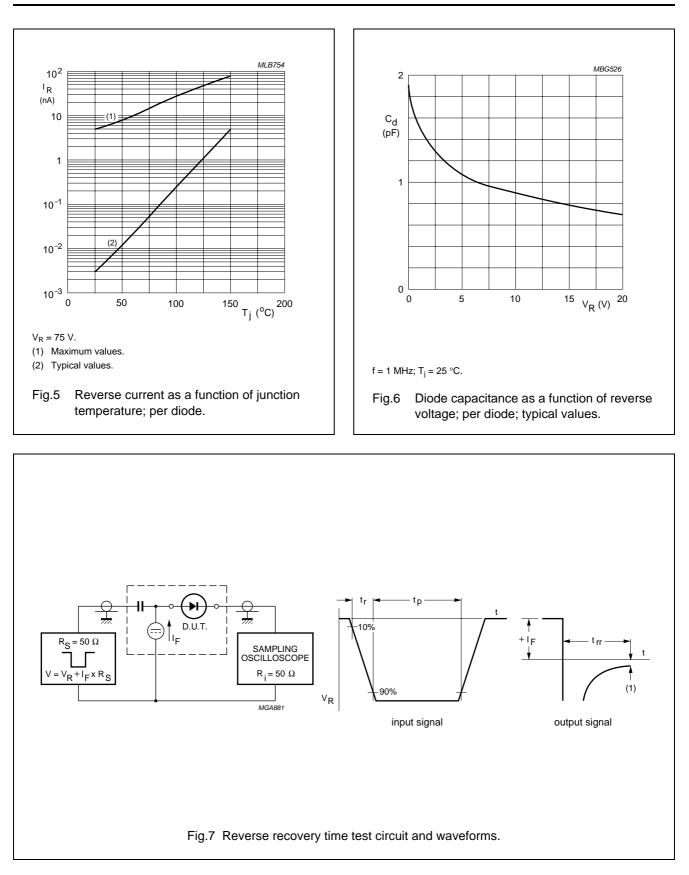
1. Device mounted on a FR4 printed-circuit board.

BAV199

GRAPHICAL DATA

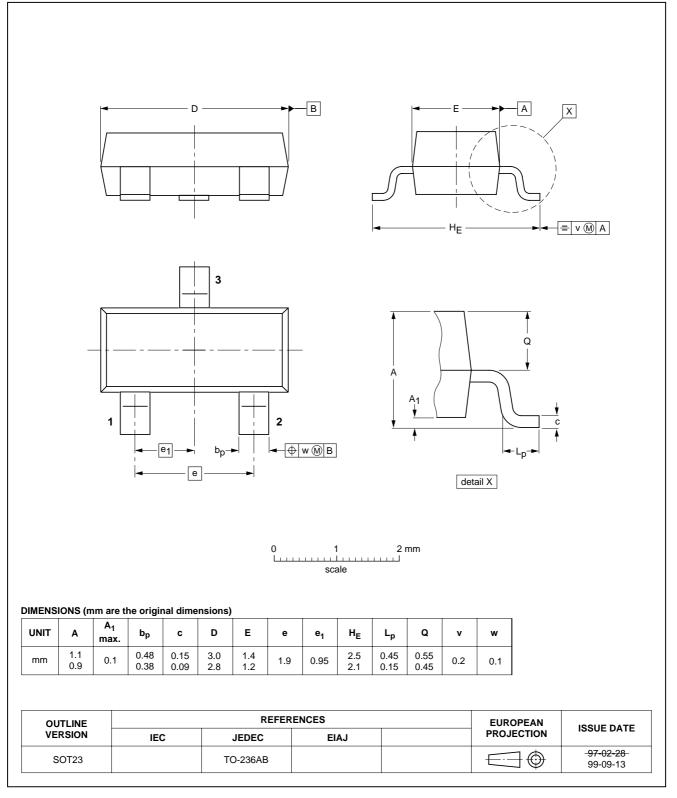


BAV199



PACKAGE OUTLINE





BAV199

SOT23

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BAV199

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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NXP Semiconductors

Customer notification

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Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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